

Plating min - Mating	0.889µm
Plating min - Termination	0.889µm
Polarized to Mating Part	Yes
Polarized to PCB	Yes
Shrouded	Fully
Stackable	No
Surface Mount Compatible (SMC)	No
Temperature Range - Operating	-40° to +105°C
Termination Interface: Style	Through Hole
Electrical	
Current - Maximum per Contact	9.0A
Voltage - Maximum	600V
Solder Process Data	
Duration at Max. Process Temperature (seconds)	005
Lead-freeProcess Capability	WAVE
Max. Cycles at Max. Process Temperature	001
Process Temperature max. C	240
Material Info	
Engineering Number	5566-12A
Reference - Drawing Numbers	
Application Specification	AS-5557-001-001
Packaging Specification	PK-5566-000, PK-5566-003-001
Product Specification	PS-5556-001-001
Sales Drawing	SD-5566-002-000
Test Summary	TS-5556-002-001

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